

# bq3285EC/LC

## Real-Time Clock (RTC)

### Features

- Direct clock/calendar replacement for IBM® AT-compatible computers and other applications
- 2.7–5.5V operation (bq3285LC); 4.5–5.5V operation (bq3285EC)
- 242 bytes of general nonvolatile storage
- Dedicated 32.768kHz output pin
- System wake-up capability—alarm interrupt output active in battery-backup mode
- Less than 0.5μA load under battery operation
- Selectable Intel or Motorola bus timing
- 24-pin plastic SOIC or SSOP

### General Description

The CMOS bq3285EC/LC is a low-power microprocessor peripheral providing a time-of-day clock and 100-year calendar with alarm features and battery operation. The architecture is based on the bq3285/7 RTC with added features: low-voltage operation, 32.768kHz output, and an extra 128 bytes of CMOS.

A 32.768kHz output is available for sustaining power-management activities. The bq3285EC 32kHz output is always on whenever  $V_{CC}$  is valid. For the bq3285LC, the output is on when the oscillator is turned on. In  $V_{CC}$  standby mode, the 32kHz is active, and the bq3285LC typically draws 100μA while the bq3285EC typically draws 300μA. Wake-up capability is provided by an alarm interrupt, which is active

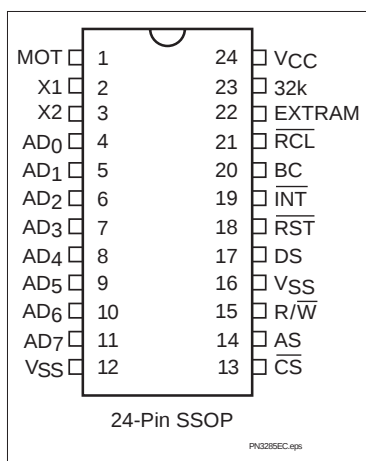
in battery-backup mode. In battery backup mode, current drain is less than 500nA.

The bq3285EC/LC write-protects the clock, calendar, and storage registers during power failure. A backup battery then maintains data and operates the clock and calendar.

The bq3285EC/LC is a fully compatible real-time clock for IBM AT-compatible computers and other applications. The only external components are a 32.768kHz crystal and a backup battery.

The bq3285EC is intended for use in 5V systems. The bq3285LC is intended for use in 3V systems; the bq3285LC, however, may also operate at 5V and then go into a 3V power-down state, write-protecting as if in a 3V system.

### Pin Connections



### Pin Names

|                                  |                                       |        |                      |
|----------------------------------|---------------------------------------|--------|----------------------|
| AD <sub>0</sub> –AD <sub>7</sub> | Multiplexed address/data input/output | 32K    | 32.768kHz output     |
| MOT                              | Bus type select input                 | EXTRAM | Extended RAM enable  |
| $\overline{CS}$                  | Chip select input                     | RCL    | RAM clear input      |
| AS                               | Address strobe input                  | BC     | 3V backup cell input |
| DS                               | Data strobe input                     | X1–X2  | Crystal inputs       |
| $\overline{R/W}$                 | Read/write input                      | VCC    | Power supply         |
| $\overline{INT}$                 | Interrupt request output              | VSS    | Ground               |
| RST                              | Reset input                           |        |                      |



|                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DS</b>                          | <b>Data strobe input</b> <p>When <math>MOT = V_{CC}</math>, DS controls data transfer during a bq3285EC/LC bus cycle. During a read cycle, the bq3285EC/LC drives the bus after the rising edge on DS. During a write cycle, the falling edge on DS is used to latch write data into the chip.</p> <p>When <math>MOT = V_{SS}</math>, the DS input is provided a signal similar to <math>\overline{RD}</math>, <math>\overline{MEMR}</math>, or <math>\overline{I/OR}</math> in an Intel-based system. The falling edge on DS is used to enable the outputs during a read cycle.</p>       | <b><math>\overline{RCL}</math></b> | <b>RAM clear input</b> <p>A low level on the <math>\overline{RCL}</math> pin causes the contents of each of the 242 storage bytes to be set to FF(hex). The contents of the clock and control registers are unaffected. This pin should be used as a user-interface input (pushbutton to ground) and not connected to the output of any active component. <math>\overline{RCL}</math> input is only recognized when held low for at least 125ms in the presence of <math>V_{CC}</math>. Using RAM clear does not affect the battery load. This pin is connected internally to a 30k<math>\Omega</math> pull-up resistor.</p> |
| <b><math>\overline{R/W}</math></b> | <b>Read/write input</b> <p>When <math>MOT = V_{CC}</math>, the level on <math>\overline{R/W}</math> identifies the direction of data transfer. A high level on <math>\overline{R/W}</math> indicates a read bus cycle, whereas a low on this pin indicates a write bus cycle.</p> <p>When <math>MOT = V_{SS}</math>, <math>\overline{R/W}</math> is provided a signal similar to <math>\overline{WR}</math>, <math>\overline{MEMW}</math>, or <math>\overline{I/OW}</math> in an Intel-based system. The rising edge on <math>\overline{R/W}</math> latches data into the bq3285EC/LC.</p> | <b>BC</b>                          | <b>3V backup cell input</b> <p>BC should be connected to a 3V backup cell for RTC operation and storage register non-volatility in the absence of system power. When <math>V_{CC}</math> slews down past <math>V_{BC}</math> (3V typical), the integral control circuitry switches the power source to BC. When <math>V_{CC}</math> returns above <math>V_{BC}</math>, the power source is switched to <math>V_{CC}</math>.</p> <p>Upon power-up, a voltage within the <math>V_{BC}</math> range must be present on the BC pin for the oscillator to start up.</p>                                                           |
| <b><math>\overline{CS}</math></b>  | <b>Chip select input</b> <p><math>\overline{CS}</math> should be driven low and held stable during the data-transfer phase of a bus cycle accessing the bq3285EC/LC.</p>                                                                                                                                                                                                                                                                                                                                                                                                                   | <b><math>\overline{RST}</math></b> | <b>Reset input</b> <p>The bq3285EC/LC is reset when <math>\overline{RST}</math> is pulled low. When reset, INT becomes high impedance, and the bq3285EC/LC is not accessible. Table 4 in the Control/Status Registers section lists the register bits that are cleared by a reset.</p> <p>Reset may be disabled by connecting <math>\overline{RST}</math> to <math>V_{CC}</math>. This allows the control bits to retain their states through power-down/power-up cycles.</p>                                                                                                                                                |
| <b><math>\overline{INT}</math></b> | <b>Interrupt request output</b> <p><math>\overline{INT}</math> is an open-drain output. This allows alarm INT to be valid in battery-backup mode. To use this feature, connect <math>\overline{INT}</math> through a resistor to a power supply other than <math>V_{CC}</math>. <math>\overline{INT}</math> is asserted low when any event flag is set and the corresponding event enable bit is also set. <math>\overline{INT}</math> becomes high-impedance whenever register C is read (see the Control/Status Registers section).</p>                                                  | <b>X1–X2</b>                       | <b>Crystal inputs</b> <p>The X1–X2 inputs are provided for an external 32.768kHz quartz crystal, Daiwa DT-26 or equivalent, with 6pF load capacitance. A trimming capacitor may be necessary for extremely precise time-base generation.</p> <p>In the absence of a crystal, a 32.768kHz waveform can be fed into the X1 input.</p>                                                                                                                                                                                                                                                                                          |
| <b>32K</b>                         | <b>32.768 kHz output</b> <p>32K provides a buffered 32.768 kHz output. The frequency remains on and fixed at 32.768kHz as long as <math>V_{CC}</math> is valid.</p>                                                                                                                                                                                                                                                                                                                                                                                                                        |                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| <b>EXTRAM</b>                      | <b>Extended RAM enable</b> <p>Enables 128 bytes of additional nonvolatile SRAM. It is connected internally to a 30k<math>\Omega</math> pull-down resistor. To access the RTC registers, EXTRAM must be low.</p>                                                                                                                                                                                                                                                                                                                                                                            |                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

bq3285EC/LC

Functional Description

Address Map

The bq3285EC/LC provides 14 bytes of clock and control/status registers and 242 bytes of general nonvolatile storage. Figure 1 illustrates the address map for the bq3285EC/LC.

Update Period

The update period for the bq3285EC/LC is one second. The bq3285EC/LC updates the contents of the clock and calendar locations during the update cycle at the end of

each update period (see Figure 2). The alarm flag bit may also be set during the update cycle.

The bq3285EC/LC copies the local register updates into the user buffer accessed by the host processor. When a 1 is written to the update transfer inhibit bit (UTI) in register B, the user copy of the clock and calendar bytes remains unchanged, while the local copy of the same bytes continues to be updated every second.

The update-in-progress bit (UIP) in register A is set  $t_{BUC}$  time before the beginning of an update cycle (see Figure 2). This bit is cleared and the update-complete flag (UF) is set at the end of the update cycle.

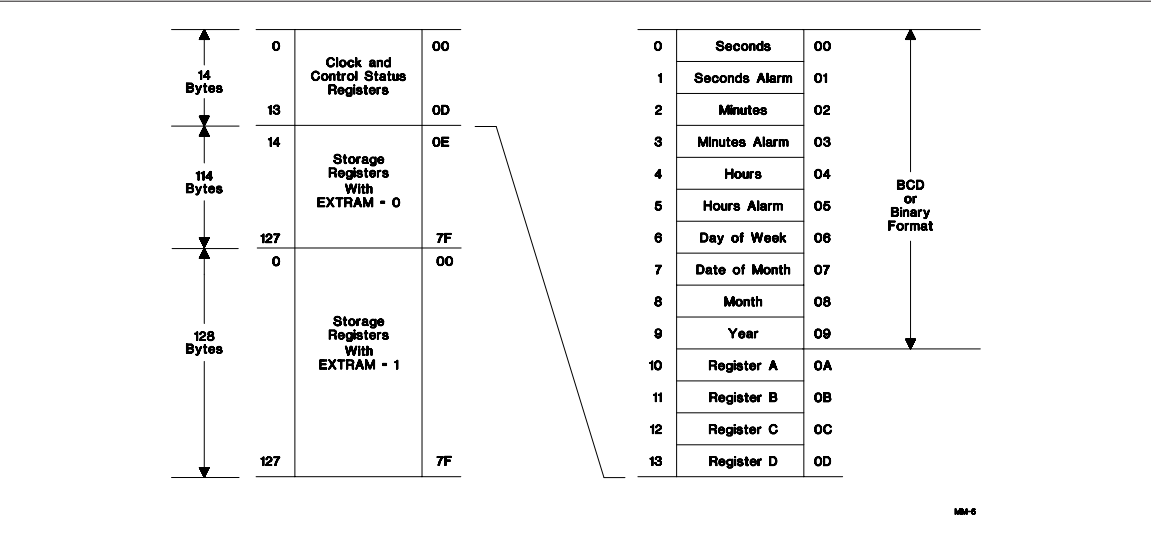


Figure 1. Address Map

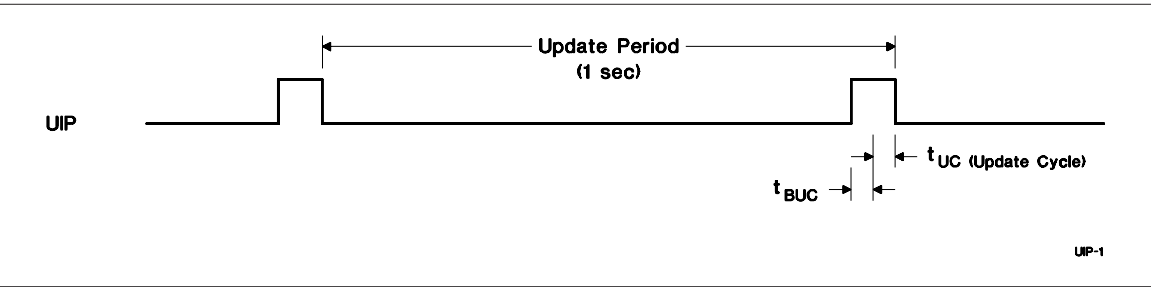


Figure 2. Update Period Timing and UIP

## Programming the RTC

The time-of-day, alarm, and calendar bytes can be written in either the BCD or binary format (see Table 2).

These steps may be followed to program the time, alarm, and calendar:

1. Modify the contents of register B:
  - a. Write a 1 to the UTI bit to prevent transfers between RTC bytes and user buffer.
  - b. Write the appropriate value to the data format (DF) bit to select BCD or binary format for all time, alarm, and calendar bytes.
  - c. Write the appropriate value to the hour format (HF) bit.
2. Write new values to all the time, alarm, and calendar locations.
3. Clear the UTI bit to allow update transfers.

On the next update cycle, the RTC updates all 10 bytes in the selected format.

**Table 2. Time, Alarm, and Calendar Formats**

| Address | RTC Bytes                   | Range   |                           |                           |
|---------|-----------------------------|---------|---------------------------|---------------------------|
|         |                             | Decimal | Binary                    | Binary-Coded Decimal      |
| 0       | Seconds                     | 0–59    | 00H–3BH                   | 00H–59H                   |
| 1       | Seconds alarm               | 0–59    | 00H–3BH                   | 00H–59H                   |
| 2       | Minutes                     | 0–59    | 00H–3BH                   | 00H–59H                   |
| 3       | Minutes alarm               | 0–59    | 00H–3BH                   | 00H–59H                   |
| 4       | Hours, 12-hour format       | 1–12    | 01H–0CH AM;<br>81H–8CH PM | 01H–12H AM;<br>81H–92H PM |
|         | Hours, 24-hour format       | 0–23    | 00H–17H                   | 00H–23H                   |
| 5       | Hours alarm, 12-hour format | 1–12    | 01H–0CH AM;<br>81H–8CH PM | 01H–12H AM;<br>81H–92H PM |
|         | Hours alarm, 24-hour format | 0–23    | 00H–17H                   | 00H–23H                   |
| 6       | Day of week (1=Sunday)      | 1–7     | 01H–07H                   | 01H–07H                   |
| 7       | Day of month                | 1–31    | 01H–1FH                   | 01H–31H                   |
| 8       | Month                       | 1–12    | 01H–0CH                   | 01H–12H                   |
| 9       | Year                        | 0–99    | 00H–63H                   | 00H–99H                   |

## bq3285EC/LC

### 32kHz Output

The bq3285EC/LC provides for a 32.768kHz output. For the bq3285EC, the output is always active whenever  $V_{CC}$  is valid ( $V_{PFD} + t_{CSR}$ ). The bq3285EC output is not affected by the bit settings in Register A. Time-keeping aspects, however, still require setting OS0-OS2. The bq3285LC output is active when the oscillator is turned on by setting the OSC0-OSC2 bits in Register A.

### Interrupts

The bq3285EC/LC allows three individually selected interrupt events to generate an interrupt request. These three interrupt events are:

- The periodic interrupt, programmable to occur once every 122μs to 500ms.
- The alarm interrupt, programmable to occur once per second to once per day, is active in battery-backup mode, providing a “wake-up” feature.
- The update-ended interrupt, which occurs at the end of each update cycle.

Each of the three interrupt events is enabled by an individual interrupt-enable bit in register B. When an event occurs, its event flag bit in register C is set. If the corresponding event enable bit is also set, then an interrupt request is generated. The interrupt request flag bit (INTF) of register C is set with every interrupt request. Reading register C clears all flag bits, including INTF, and makes  $\overline{INT}$  high-impedance.

Two methods can be used to process bq3285EC/LC interrupt events:

- Enable interrupt events and use the interrupt request output to invoke an interrupt service routine.
- Do not enable the interrupts and use a polling routine to periodically check the status of the flag bits.

The individual interrupt sources are described in detail in the following sections.

**Table 3. Periodic Interrupt Rate**

| Register A Bits |      |      |     |     |     |     | Periodic Interrupt               |       |
|-----------------|------|------|-----|-----|-----|-----|----------------------------------|-------|
| OSC2            | OSC1 | OSC0 | RS3 | RS2 | RS1 | RS0 | Period                           | Units |
| 0               | 1    | 0    | 0   | 0   | 0   | 0   | None                             |       |
| 0               | 1    | 0    | 0   | 0   | 0   | 1   | 3.90625                          | ms    |
| 0               | 1    | 0    | 0   | 0   | 1   | 0   | 7.8125                           | ms    |
| 0               | 1    | 0    | 0   | 0   | 1   | 1   | 122.070                          | μs    |
| 0               | 1    | 0    | 0   | 1   | 0   | 0   | 244.141                          | μs    |
| 0               | 1    | 0    | 0   | 1   | 0   | 1   | 488.281                          | μs    |
| 0               | 1    | 0    | 0   | 1   | 1   | 0   | 976.5625                         | μs    |
| 0               | 1    | 0    | 0   | 1   | 1   | 1   | 1.95315                          | ms    |
| 0               | 1    | 0    | 1   | 0   | 0   | 0   | 3.90625                          | ms    |
| 0               | 1    | 0    | 1   | 0   | 0   | 1   | 7.8125                           | ms    |
| 0               | 1    | 0    | 1   | 0   | 1   | 0   | 15.625                           | ms    |
| 0               | 1    | 0    | 1   | 0   | 1   | 1   | 31.25                            | ms    |
| 0               | 1    | 0    | 1   | 1   | 0   | 0   | 62.5                             | ms    |
| 0               | 1    | 0    | 1   | 1   | 0   | 1   | 125                              | ms    |
| 0               | 1    | 0    | 1   | 1   | 1   | 0   | 250                              | ms    |
| 0               | 1    | 0    | 1   | 1   | 1   | 1   | 500                              | ms    |
| 0               | 1    | 1    | X   | X   | X   | X   | same as above defined by RS3–RS0 |       |

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# bq3285EC/LC

## Power-Down/Power-Up Cycle

The bq3285EC and bq3285LC power-up/power-down cycles are different. The bq3285LC continuously monitors  $V_{CC}$  for out-of-tolerance. During a power failure, when  $V_{CC}$  falls below  $V_{PFD}$  (2.53V typical), the bq3285LC write-protects the clock and storage registers. The power source is switched to BC when  $V_{CC}$  is less than  $V_{PFD}$  and BC is greater than  $V_{PFD}$ , or when  $V_{CC}$  is less than  $V_{BC}$  and  $V_{BC}$  is less than  $V_{PFD}$ . RTC operation and storage data are sustained by a valid backup energy source. When  $V_{CC}$  is above  $V_{PFD}$ , the power source is  $V_{CC}$ . Write-protection continues for  $t_{CSR}$  time after  $V_{CC}$  rises above  $V_{PFD}$ .

The bq3285EC continuously monitors  $V_{CC}$  for out-of-tolerance. During a power failure, when  $V_{CC}$  falls below  $V_{PFD}$  (4.17V typical), the bq3285EC write-protects the clock and storage registers. When  $V_{CC}$  is below  $V_{BC}$  (3V typical), the power source is switched to BC. RTC operation and storage data are sustained by a valid backup energy source. When  $V_{CC}$  is above  $V_{BC}$ , the power source is  $V_{CC}$ . Write-protection continues for  $t_{CSR}$  time after  $V_{CC}$  rises above  $V_{PFD}$ .

## Control/Status Registers

The four control/status registers of the bq3285EC/LC are accessible regardless of the status of the update cycle (see Table 4).

### Register A

| Register A Bits |     |     |     |     |     |     |     |
|-----------------|-----|-----|-----|-----|-----|-----|-----|
| 7               | 6   | 5   | 4   | 3   | 2   | 1   | 0   |
| UIP             | OS2 | OS1 | OS0 | RS3 | RS2 | RS1 | RS0 |

Register A programs:

- The frequency of the periodic event rate.
- Oscillator operation.

- Time-keeping

Register A provides:

- Status of the update cycle.

### RS0–RS3 - Frequency Select

| 7 | 6 | 5 | 4 | 3   | 2   | 1   | 0   |
|---|---|---|---|-----|-----|-----|-----|
| - | - | - | - | RS3 | RS2 | RS1 | RS0 |

These bits select the periodic interrupt rate, as shown in Table 3.

### OS0–OS2 - Oscillator Control

| 7 | 6   | 5   | 4   | 3 | 2 | 1 | 0 |
|---|-----|-----|-----|---|---|---|---|
| - | OS2 | OS1 | OS0 | - | - | - | - |

These three bits control the state of the oscillator and divider stages. A pattern of 010 or 011 enables RTC operation by turning on the oscillator and enabling the frequency divider. This pattern must be set to turn the oscillator on for the bq3285LC and to ensure that the bq3285EC/LC will keep time in battery-backup mode. A pattern of 11X turns the oscillator on, but keeps the frequency divider disabled. When 010 is written, the RTC begins its first update after 500ms.

### UIP - Update Cycle Status

| 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|---|---|---|---|---|---|---|
| UIP | - | - | - | - | - | - | - |

This read-only bit is set prior to the update cycle. When UIP equals 1, an RTC update cycle may be in progress. UIP is cleared at the end of each update cycle. This bit is also cleared when the update transfer inhibit (UTI) bit in register B is 1.

**Table 4. Control/Status Registers**

| Reg. | Loc. (Hex) | Read | Write            | Bit Name and State on Reset |    |     |    |     |    |     |    |     |    |     |    |     |    |         |    |
|------|------------|------|------------------|-----------------------------|----|-----|----|-----|----|-----|----|-----|----|-----|----|-----|----|---------|----|
|      |            |      |                  | 7 (MSB)                     |    | 6   |    | 5   |    | 4   |    | 3   |    | 2   |    | 1   |    | 0 (LSB) |    |
| A    | 0A         | Yes  | Yes <sup>1</sup> | UIP                         | na | OS2 | na | OS1 | na | OS0 | na | RS3 | na | RS2 | na | RS1 | na | RS0     | na |
| B    | 0B         | Yes  | Yes              | UTI                         | na | PIE | 0  | AIE | 0  | UIE | 0  | -   | 0  | DF  | na | HF  | na | DSE     | na |
| C    | 0C         | Yes  | No               | INTF                        | 0  | PF  | 0  | AF  | 0  | UF  | 0  | -   | 0  | -   | na | -   | 0  | -       | 0  |
| D    | 0D         | Yes  | No               | VRT                         | na | -   | 0  | -   | 0  | -   | 0  | -   | 0  | -   | 0  | -   | 0  | -       | 0  |

**Notes:** na = not affected.

1. Except bit 7.

**Register B**

| Register B Bits |     |     |     |   |    |    |     |
|-----------------|-----|-----|-----|---|----|----|-----|
| 7               | 6   | 5   | 4   | 3 | 2  | 1  | 0   |
| UTI             | PIE | AIE | UIE | - | DF | HF | DSE |

Register B enables:

- Update cycle transfer operation
- Interrupt events
- Daylight saving adjustment

Register B selects:

- Clock and calendar data formats

All bits of register B are read/write.

**Bit 3 - Unused Bit.****DSE - Daylight Saving Enable**

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0   |
|---|---|---|---|---|---|---|-----|
| - | - | - | - | - | - | - | DSE |

This bit enables daylight-saving time adjustments when written to 1:

- On the last Sunday in October, the first time the bq3285EC/LC increments past 1:59:59 AM, the time falls back to 1:00:00 AM.
- On the first Sunday in April, the time springs forward from 2:00:00 AM to 3:00:00 AM.

**HF - Hour Format**

| 7 | 6 | 5 | 4 | 3 | 2 | 1  | 0 |
|---|---|---|---|---|---|----|---|
| - | - | - | - | - | - | HF | - |

This bit selects the time-of-day and alarm hour format:

- 1 = 24-hour format
- 0 = 12-hour format

**DF - Data Format**

| 7 | 6 | 5 | 4 | 3 | 2  | 1 | 0 |
|---|---|---|---|---|----|---|---|
| - | - | - | - | - | DF | - | - |

This bit selects the numeric format in which the time, alarm, and calendar bytes are represented:

- 1 = Binary
- 0 = BCD

**UIE - Update Cycle Interrupt Enable**

| 7 | 6 | 5 | 4   | 3 | 2 | 1 | 0 |
|---|---|---|-----|---|---|---|---|
| - | - | - | UIE | - | - | - | - |

This bit enables an interrupt request due to an update ended interrupt event:

- 1 = Enabled
- 0 = Disabled

The UIE bit is automatically cleared when the UTI bit equals 1.

**AIE - Alarm Interrupt Enable**

| 7 | 6 | 5   | 4 | 3 | 2 | 1 | 0 |
|---|---|-----|---|---|---|---|---|
| - | - | AIE | - | - | - | - | - |

This bit enables an interrupt request due to an alarm interrupt event:

- 1 = Enabled
- 0 = Disabled

**PIE - Periodic Interrupt Enable**

| 7 | 6   | 5 | 4 | 3 | 2 | 1 | 0 |
|---|-----|---|---|---|---|---|---|
| - | PIE | - | - | - | - | - | - |

This bit enables an interrupt request due to a periodic interrupt event:

- 1 = Enabled
- 0 = Disabled

**UTI - Update Transfer Inhibit**

| 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----|---|---|---|---|---|---|---|
| UTI | - | - | - | - | - | - | - |

This bit inhibits the transfer of RTC bytes to the user buffer:

- 1 = Inhibits transfer and clears UIE
- 0 = Allows transfer

## bq3285EC/LC

### Register C

| Register C Bits |    |    |    |   |   |   |   |
|-----------------|----|----|----|---|---|---|---|
| 7               | 6  | 5  | 4  | 3 | 2 | 1 | 0 |
| INTF            | PF | AF | UF | 0 | - | 0 | 0 |

Register C is the read-only event status register.

#### Bits 0, 1, 2, 3 - Unused Bits

|   |   |   |   |   |   |   |   |
|---|---|---|---|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| - | - | - | - | 0 | - | 0 | 0 |

These bits are always set to 0.

#### UF - Update Event Flag

|   |   |   |    |   |   |   |   |
|---|---|---|----|---|---|---|---|
| 7 | 6 | 5 | 4  | 3 | 2 | 1 | 0 |
| - | - | - | UF | - | - | - | - |

This bit is set to a 1 at the end of the update cycle. Reading register C clears this bit.

#### AF - Alarm Event Flag

|   |   |    |   |   |   |   |   |
|---|---|----|---|---|---|---|---|
| 7 | 6 | 5  | 4 | 3 | 2 | 1 | 0 |
| - | - | AF | - | - | - | - | - |

This bit is set to a 1 when an alarm event occurs. Reading register C clears this bit.

#### PF - Periodic Event Flag

|   |    |   |   |   |   |   |   |
|---|----|---|---|---|---|---|---|
| 7 | 6  | 5 | 4 | 3 | 2 | 1 | 0 |
| - | PF | - | - | - | - | - | - |

This bit is set to a 1 every  $t_{PI}$  time, where  $t_{PI}$  is the time period selected by the settings of RS0–RS3 in register A. Reading register C clears this bit.

#### INTF - Interrupt Request Flag

|      |   |   |   |   |   |   |   |
|------|---|---|---|---|---|---|---|
| 7    | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| INTF | - | - | - | - | - | - | - |

This flag is set to a 1 when any of the following is true:

AIE = 1 and AF = 1

PIE = 1 and PF = 1

UIE = 1 and UF = 1

Reading register C clears this bit.

### Register D

| Register D Bits |   |   |   |   |   |   |   |
|-----------------|---|---|---|---|---|---|---|
| 7               | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| VRT             | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Register D is the read-only data integrity status register.

|   |   |   |   |   |   |   |   |
|---|---|---|---|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| - | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

#### Bits 0–6 - Unused Bits

These bits are always set to 0.

|     |   |   |   |   |   |   |   |
|-----|---|---|---|---|---|---|---|
| 7   | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| VRT | - | - | - | - | - | - | - |

#### VRT - Valid RAM and Time

1 = Valid backup energy source

0 = Backup energy source is depleted

When the backup energy source is depleted (VRT = 0), data integrity of the RTC and storage registers is not guaranteed.

**Absolute Maximum Ratings—bq3285EC**

| Symbol              | Parameter                                                                           | Value       | Unit | Conditions                             |
|---------------------|-------------------------------------------------------------------------------------|-------------|------|----------------------------------------|
| V <sub>CC</sub>     | DC voltage applied on V <sub>CC</sub> relative to V <sub>SS</sub>                   | -0.3 to 7.0 | V    |                                        |
| V <sub>T</sub>      | DC voltage applied on any pin excluding V <sub>CC</sub> relative to V <sub>SS</sub> | -0.3 to 7.0 | V    | V <sub>T</sub> ≤ V <sub>CC</sub> + 0.3 |
| T <sub>OPR</sub>    | Operating temperature                                                               | 0 to +70    | °C   | Commercial                             |
| T <sub>STG</sub>    | Storage temperature                                                                 | -55 to +125 | °C   |                                        |
| T <sub>BIAS</sub>   | Temperature under bias                                                              | -40 to +85  | °C   |                                        |
| T <sub>SOLDER</sub> | Soldering temperature                                                               | 260         | °C   | For 10 seconds                         |

**Note:** Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

**Absolute Maximum Ratings—bq3285LC**

| Symbol              | Parameter                                                                           | Value       | Unit | Conditions                             |
|---------------------|-------------------------------------------------------------------------------------|-------------|------|----------------------------------------|
| V <sub>CC</sub>     | DC voltage applied on V <sub>CC</sub> relative to V <sub>SS</sub>                   | -0.3 to 7.0 | V    |                                        |
| V <sub>T</sub>      | DC voltage applied on any pin excluding V <sub>CC</sub> relative to V <sub>SS</sub> | -0.3 to 7.0 | V    | V <sub>T</sub> ≤ V <sub>CC</sub> + 0.3 |
| T <sub>OPR</sub>    | Operating temperature                                                               | 0 to +70    | °C   | Commercial                             |
| T <sub>STG</sub>    | Storage temperature                                                                 | -55 to +125 | °C   |                                        |
| T <sub>BIAS</sub>   | Temperature under bias                                                              | -40 to +85  | °C   |                                        |
| T <sub>SOLDER</sub> | Soldering temperature                                                               | 260         | °C   | For 10 seconds                         |

**Note:** Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

## bq3285EC/LC

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### Recommended DC Operating Conditions—bq3285EC ( $T_A = T_{OPR}$ )

| Symbol          | Parameter           | Minimum | Typical | Maximum               | Unit |
|-----------------|---------------------|---------|---------|-----------------------|------|
| V <sub>CC</sub> | Supply voltage      | 4.5     | 5.0     | 5.5                   | V    |
| V <sub>SS</sub> | Supply voltage      | 0       | 0       | 0                     | V    |
| V <sub>IL</sub> | Input low voltage   | -0.3    | -       | 0.8                   | V    |
| V <sub>IH</sub> | Input high voltage  | 2.2     | -       | V <sub>CC</sub> + 0.3 | V    |
| V <sub>BC</sub> | Backup cell voltage | 2.4     | -       | 4.0                   | V    |

**Note:** Typical values indicate operation at  $T_A = 25^\circ\text{C}$ .

### Recommended DC Operating Conditions—bq3285LC ( $T_A = T_{OPR}$ )

| Symbol          | Parameter           | Minimum | Typical | Maximum               | Unit |
|-----------------|---------------------|---------|---------|-----------------------|------|
| V <sub>CC</sub> | Supply voltage      | 2.7     | 3.0     | 5.5                   | V    |
| V <sub>SS</sub> | Supply voltage      | 0       | 0       | 0                     | V    |
| V <sub>IL</sub> | Input low voltage   | -0.3    | -       | 0.6                   | V    |
| V <sub>IH</sub> | Input high voltage  | 2.2     | -       | V <sub>CC</sub> + 0.3 | V    |
| V <sub>BC</sub> | Backup cell voltage | 2.4     | -       | 4.0                   | V    |

**Note:** Typical values indicate operation at  $T_A = 25^\circ\text{C}$ .

### Crystal Specifications—bq3285EC/LC (DT-26 or Equivalent)

| Symbol                         | Parameter                    | Minimum | Typical | Maximum | Unit   |
|--------------------------------|------------------------------|---------|---------|---------|--------|
| f <sub>0</sub>                 | Oscillation frequency        | -       | 32.768  | -       | kHz    |
| C <sub>L</sub>                 | Load capacitance             | -       | 6       | -       | pF     |
| T <sub>P</sub>                 | Temperature turnover point   | 20      | 25      | 30      | °C     |
| k                              | Parabolic curvature constant | -       | -       | -0.042  | ppm/°C |
| Q                              | Quality factor               | 40,000  | 70,000  | -       |        |
| R <sub>1</sub>                 | Series resistance            | -       | -       | 45      | KΩ     |
| C <sub>0</sub>                 | Shunt capacitance            | -       | 1.1     | 1.8     | pF     |
| C <sub>0</sub> /C <sub>1</sub> | Capacitance ratio            | -       | 430     | 600     |        |
| D <sub>L</sub>                 | Drive level                  | -       | -       | 1       | μW     |
| Δf/f <sub>0</sub>              | Aging (first year at 25°C)   | -       | 1       | -       | ppm    |

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**DC Electrical Characteristics—bq3285EC** ( $T_A = T_{OPR}$ ,  $V_{CC} = 5V$ )

| Symbol      | Parameter                                      | Minimum | Typical  | Maximum | Unit    | Conditions/Notes                                                                       |
|-------------|------------------------------------------------|---------|----------|---------|---------|----------------------------------------------------------------------------------------|
| $I_{LI}$    | Input leakage current                          | -       | -        | $\pm 1$ | $\mu A$ | $V_{IN} = V_{SS}$ to $V_{CC}$                                                          |
| $I_{LO}$    | Output leakage current                         | -       | -        | $\pm 1$ | $\mu A$ | $AD_0$ – $AD_7$ and $\overline{INT}$ in high impedance, $V_{OUT} = V_{SS}$ to $V_{CC}$ |
| $V_{OH}$    | Output high voltage                            | 2.4     | -        | -       | V       | $I_{OH} = -2.0$ mA                                                                     |
| $V_{OL}$    | Output low voltage                             | -       | -        | 0.4     | V       | $I_{OL} = 4.0$ mA                                                                      |
| $I_{CC}$    | Operating supply current                       | -       | 7        | 15      | mA      | Min. cycle, duty = 100%, $I_{OH} = 0$ mA, $I_{OL} = 0$ mA                              |
| $I_{CCSB}$  | Standby supply current                         | -       | 300      | -       | $\mu A$ | $V_{IN} = V_{SS}$ or $V_{CC}$ , $CS \geq V_{CC} - 0.2$                                 |
| $V_{SO}$    | Supply switch-over voltage                     | -       | $V_{BC}$ | -       | V       |                                                                                        |
| $I_{CCB}$   | Battery operation current                      | -       | 0.3      | 0.5     | $\mu A$ | $V_{BC} = 3V$ , $T_A = 25^\circ C$                                                     |
| $V_{PFD}$   | Power-fail-detect voltage                      | 4.0     | 4.17     | 4.35    | V       |                                                                                        |
| $I_{RCL}$   | Input current when $\overline{RCL} = V_{SS}$ . | -       | -        | 185     | $\mu A$ | Internal 30K pull-up                                                                   |
| $I_{MOTH}$  | Input current when $MOT = V_{CC}$              | -       | -        | -185    | $\mu A$ | Internal 30K pull-down                                                                 |
|             | Input current when $MOT = V_{SS}$              | -       | -        | 0       | $\mu A$ | Internal 30K pull-down                                                                 |
| $I_{XTRAM}$ | Input current when $EXTRAM = V_{CC}$           | -       | -        | -185    | $\mu A$ | Internal 30K pull-down                                                                 |
|             | Input current when $EXTRAM = V_{SS}$           | -       | -        | 0       | $\mu A$ | Internal 30K pull-down                                                                 |

**Note:** Typical values indicate operation at  $T_A = 25^\circ C$ ,  $V_{CC} = 5V$  or  $V_{BC} = 3V$ .

## bq3285EC/LC

### DC Electrical Characteristics—bq3285LC ( $T_A = T_{OPR}$ , $V_{CC} = 3V \pm 10\%$ )

| Symbol      | Parameter                                    | Minimum | Typical <sup>1</sup> | Maximum | Unit    | Conditions/Notes                                                                                           |
|-------------|----------------------------------------------|---------|----------------------|---------|---------|------------------------------------------------------------------------------------------------------------|
| $I_{LI}$    | Input leakage current                        | -       | -                    | $\pm 1$ | $\mu A$ | $V_{IN} = V_{SS}$ to $V_{CC}$                                                                              |
| $I_{LO}$    | Output leakage current                       | -       | -                    | $\pm 1$ | $\mu A$ | AD <sub>0</sub> –AD <sub>7</sub> and $\overline{INT}$ in high impedance,<br>$V_{OUT} = V_{SS}$ to $V_{CC}$ |
| $V_{OH}$    | Output high voltage                          | 2.2     | -                    | -       | V       | $I_{OH} = -1.0$ mA                                                                                         |
| $V_{OL}$    | Output low voltage                           | -       | -                    | 0.4     | V       | $I_{OL} = 2.0$ mA                                                                                          |
| $I_{CC}$    | Operating supply current                     | -       | 5 <sup>2</sup>       | 9       | mA      | Min. cycle, duty = 100%,<br>$I_{OH} = 0$ mA, $I_{OL} = 0$ mA                                               |
| $I_{CCSB}$  | Standby supply current                       | -       | 100 <sup>3</sup>     | -       | $\mu A$ | $V_{IN} = V_{SS}$ or $V_{CC}$ ,<br>$CS \geq V_{CC} - 0.2$                                                  |
| $V_{SO}$    | Supply switch-over voltage                   | -       | $V_{PFD}$            | -       | V       | $V_{BC} > V_{PFD}$                                                                                         |
|             |                                              | -       | $V_{BC}$             | -       | V       | $V_{BC} < V_{PFD}$                                                                                         |
| $I_{CCB}$   | Battery operation current                    | -       | 0.3                  | 0.5     | $\mu A$ | $V_{BC} = 3V$ , $T_A = 25^\circ C$ ,<br>$V_{CC} < V_{BC}$                                                  |
| $V_{PFD}$   | Power-fail-detect voltage                    | 2.4     | 2.53                 | 2.65    | V       |                                                                                                            |
| $I_{RCL}$   | Input current when $\overline{RCL} = V_{SS}$ | -       | -                    | 120     | $\mu A$ | Internal 30K pull-up                                                                                       |
| $I_{MOTH}$  | Input current when MOT = $V_{CC}$            | -       | -                    | -120    | $\mu A$ | Internal 30K pull-down                                                                                     |
|             | Input current when MOT = $V_{SS}$            | -       | -                    | 0       | $\mu A$ | Internal 30K pull-down                                                                                     |
| $I_{XTRAM}$ | Input current when EXTRAM = $V_{CC}$         | -       | -                    | -120    | $\mu A$ | Internal 30K pull-down                                                                                     |
|             | Input current when EXTRAM = $V_{SS}$         | -       | -                    | 0       | $\mu A$ | Internal 30K pull-down                                                                                     |

- Notes:**
1. Typical values indicate operation at  $T_A = 25^\circ C$ ,  $V_{CC} = 3V$ .
  2. 7mA at  $V_{CC} = 5V$
  3. 300 $\mu A$  at  $V_{CC} = 5V$

**Capacitance—bq3285EC/LC** ( $T_A = 25^\circ\text{C}$ ,  $F = 1\text{MHz}$ ,  $V_{CC} = 5.0\text{V}$ )

| Symbol    | Parameter                | Minimum | Typical | Maximum | Unit | Conditions            |
|-----------|--------------------------|---------|---------|---------|------|-----------------------|
| $C_{I/O}$ | Input/output capacitance | -       | -       | 7       | pF   | $V_{OUT} = 0\text{V}$ |
| $C_{IN}$  | Input capacitance        | -       | -       | 5       | pF   | $V_{IN} = 0\text{V}$  |

**Note:** This parameter is sampled and not 100% tested. It does not include the X1 or X2 pin.

**AC Test Conditions—bq3285EC**

| Parameter                                | Test Conditions                    |
|------------------------------------------|------------------------------------|
| Input pulse levels                       | 0 to 3.0 V                         |
| Input rise and fall times                | 5 ns                               |
| Input and output timing reference levels | 1.5 V (unless otherwise specified) |
| Output load (including scope and jig)    | See Figures 4 and 5                |



Figure 4. Output Load—bq3285EC

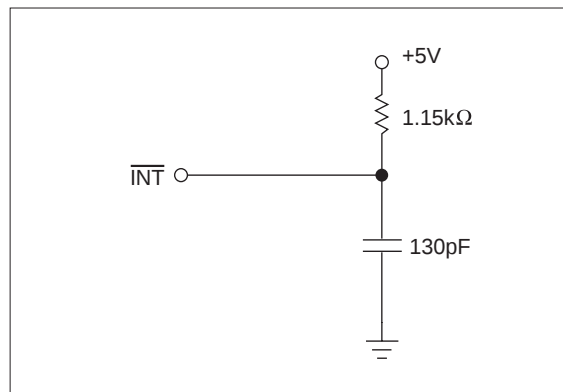


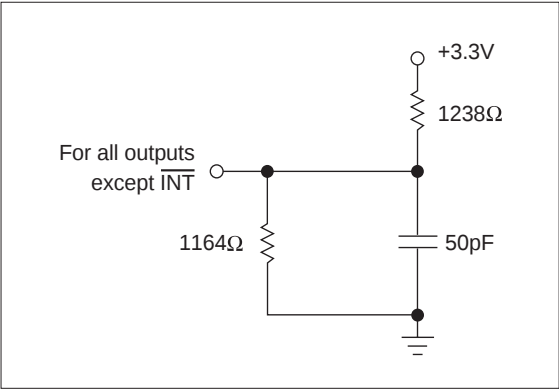
Figure 5. Output Load—bq3285EC

**bq3285EC/LC**

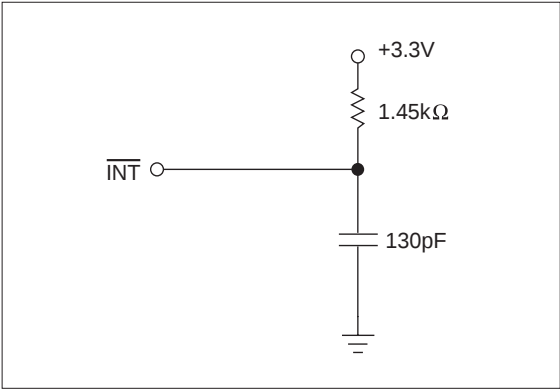
**AC Test Conditions—bq3285LC**

| Parameter                                | Test Conditions                    |
|------------------------------------------|------------------------------------|
| Input pulse levels                       | 0 to 2.3 V, $V_{CC} = 3V^1$        |
| Input rise and fall times                | 5 ns                               |
| Input and output timing reference levels | 1.2 V (unless otherwise specified) |
| Output load (including scope and jig)    | See Figures 6 and 7                |

**Note:** 1. For 5V timing, please refer to bq3285EC.



**Figure 6. Output Load—bq3285LC**



**Figure 7. Output Load B—bq3285LC**

**Read/Write Timing—bq3285EC** ( $T_A = T_{OPR}$ ,  $V_{CC} = 5V \pm 10\%$ )

| Symbol           | Parameter                                                       | Minimum | Typical | Maximum | Unit | Notes       |
|------------------|-----------------------------------------------------------------|---------|---------|---------|------|-------------|
| t <sub>CYC</sub> | Cycle time                                                      | 160     | -       | -       | ns   |             |
| t <sub>DSL</sub> | DS low or $\overline{RD}/\overline{WR}$ high time               | 80      | -       | -       | ns   |             |
| t <sub>DSH</sub> | DS high or $\overline{RD}/\overline{WR}$ low time               | 55      | -       | -       | ns   |             |
| t <sub>RWH</sub> | $R/\overline{W}$ hold time                                      | 0       | -       | -       | ns   |             |
| t <sub>RWS</sub> | $R/\overline{W}$ setup time                                     | 10      | -       | -       | ns   |             |
| t <sub>CS</sub>  | Chip select setup time                                          | 5       | -       | -       | ns   |             |
| t <sub>CH</sub>  | Chip select hold time                                           | 0       | -       | -       | ns   |             |
| t <sub>DHR</sub> | Read data hold time                                             | 0       | -       | 25      | ns   |             |
| t <sub>DHW</sub> | Write data hold time                                            | 0       | -       | -       | ns   |             |
| t <sub>AS</sub>  | Address setup time                                              | 20      | -       | -       | ns   |             |
| t <sub>AH</sub>  | Address hold time                                               | 5       | -       | -       | ns   |             |
| t <sub>DAS</sub> | Delay time, DS to AS rise                                       | 10      | -       | -       | ns   |             |
| t <sub>ASW</sub> | Pulse width, AS high                                            | 30      | -       | -       | ns   |             |
| t <sub>ASD</sub> | Delay time, AS to DS rise ( $\overline{RD}/\overline{WR}$ fall) | 35      | -       | -       | ns   |             |
| t <sub>OD</sub>  | Output data delay time from DS rise (RD fall)                   | -       | -       | 50      | ns   |             |
| t <sub>DW</sub>  | Write data setup time                                           | 30      | -       | -       | ns   |             |
| t <sub>BUC</sub> | Delay time before update cycle                                  | -       | 244     | -       | μs   |             |
| t <sub>PI</sub>  | Periodic interrupt time interval                                | -       | -       | -       | -    | See Table 3 |
| t <sub>UC</sub>  | Time of update cycle                                            | -       | 1       | -       | μs   |             |

## bq3285EC/LC

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### Read/Write Timing—bq3285LC ( $T_A = T_{OPR}$ , $V_{CC} = 3V \pm 10\%$ )

| Symbol           | Parameter                                                       | Minimum | Typical | Maximum | Unit    | Notes       |
|------------------|-----------------------------------------------------------------|---------|---------|---------|---------|-------------|
| t <sub>CYC</sub> | Cycle time                                                      | 270     | -       | -       | ns      |             |
| t <sub>DSL</sub> | DS low or $\overline{RD}/\overline{WR}$ high time               | 135     | -       | -       | ns      |             |
| t <sub>DSH</sub> | DS high or $\overline{RD}/\overline{WR}$ low time               | 90      | -       | -       | ns      |             |
| t <sub>RWH</sub> | $R/\overline{W}$ hold time                                      | 0       | -       | -       | ns      |             |
| t <sub>RWS</sub> | $R/\overline{W}$ setup time                                     | 15      | -       | -       | ns      |             |
| t <sub>CS</sub>  | Chip select setup time                                          | 8       | -       | -       | ns      |             |
| t <sub>CH</sub>  | Chip select hold time                                           | 0       | -       | -       | ns      |             |
| t <sub>DHR</sub> | Read data hold time                                             | 0       | -       | 40      | ns      |             |
| t <sub>DHW</sub> | Write data hold time                                            | 0       | -       | -       | ns      |             |
| t <sub>AS</sub>  | Address setup time                                              | 30      | -       | -       | ns      |             |
| t <sub>AH</sub>  | Address hold time                                               | 15      | -       | -       | ns      |             |
| t <sub>DAS</sub> | Delay time, DS to AS rise                                       | 15      | -       | -       | ns      |             |
| t <sub>ASW</sub> | Pulse width, AS high                                            | 50      | -       | -       | ns      |             |
| t <sub>ASD</sub> | Delay time, AS to DS rise ( $\overline{RD}/\overline{WR}$ fall) | 55      | -       | -       | ns      |             |
| t <sub>OD</sub>  | Output data delay time from DS rise (RD fall)                   | -       | -       | 100     | ns      |             |
| t <sub>DW</sub>  | Write data setup time                                           | 50      | -       | -       | ns      |             |
| t <sub>BUC</sub> | Delay time before update cycle                                  | -       | 244     | -       | $\mu s$ |             |
| t <sub>PI</sub>  | Periodic interrupt time interval                                | -       | -       | -       | -       | See Table 3 |
| t <sub>UC</sub>  | Time of update cycle                                            | -       | 1       | -       | $\mu s$ |             |

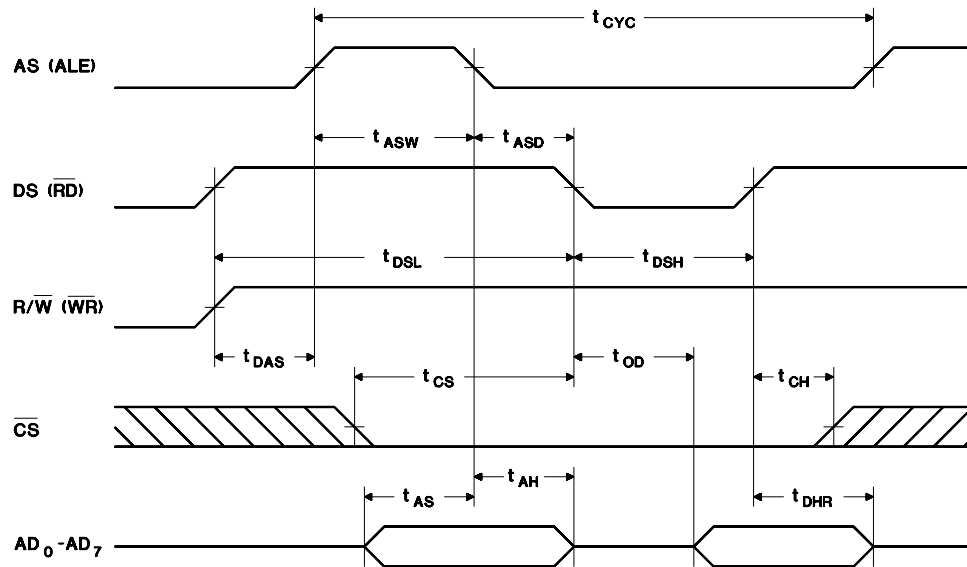
## Motorola Bus Read/Write Timing—bq3285EC/LC



RC-4

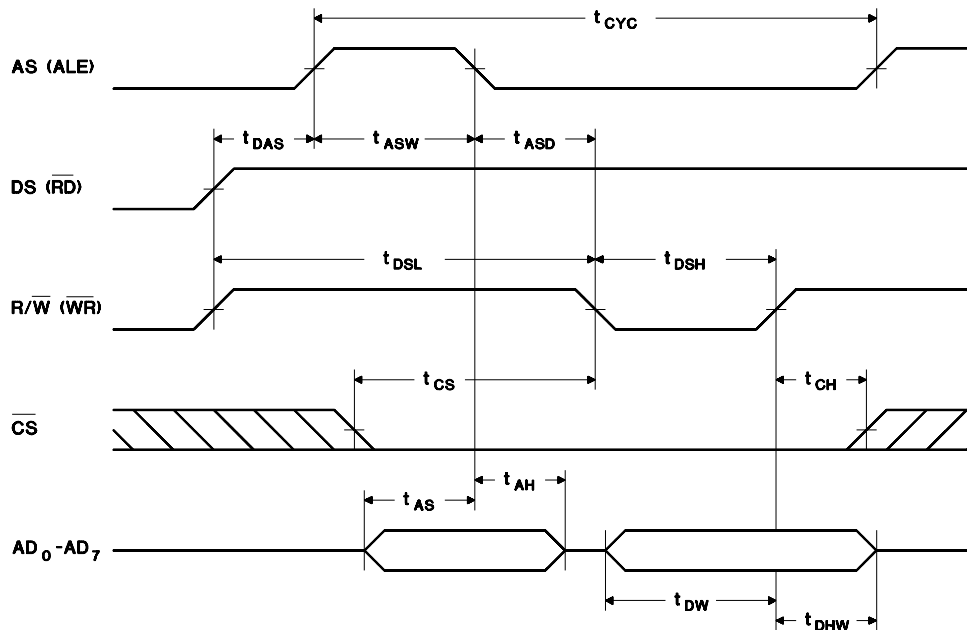
## bq3285EC/LC

### Intel Bus Read Timing—bq3285EC/LC



RC-5

### Intel Bus Write—bq3285EC/LC



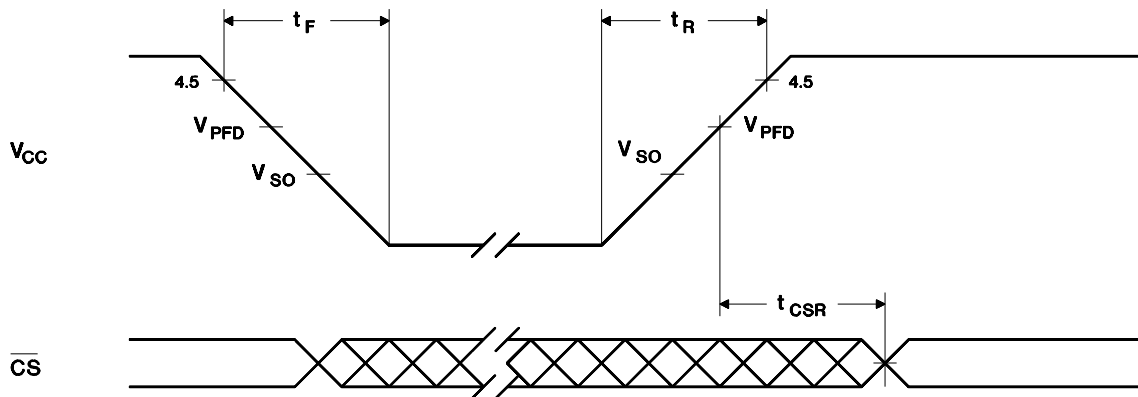
WC-5

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**Power-Down/Power-Up Timing—bq3285EC** ( $T_A = T_{OPR}$ )

| Symbol    | Parameter                                  | Minimum | Typical | Maximum | Unit    | Conditions                                                                    |
|-----------|--------------------------------------------|---------|---------|---------|---------|-------------------------------------------------------------------------------|
| $t_F$     | $V_{CC}$ slew from 4.5V to 0V              | 300     | -       | -       | $\mu s$ |                                                                               |
| $t_R$     | $V_{CC}$ slew from 0V to 4.5V              | 100     | -       | -       | $\mu s$ |                                                                               |
| $t_{CSR}$ | $\overline{CS}$ at $V_{IH}$ after power-up | 20      | -       | 200     | ms      | Internal write-protection period after $V_{CC}$ passes $V_{PFD}$ on power-up. |

**Caution:** Negative undershoots below the absolute maximum rating of -0.3V in battery-backup mode may affect data integrity.

**Power-Down/Power-Up Timing—bq3285EC**

PD-4A

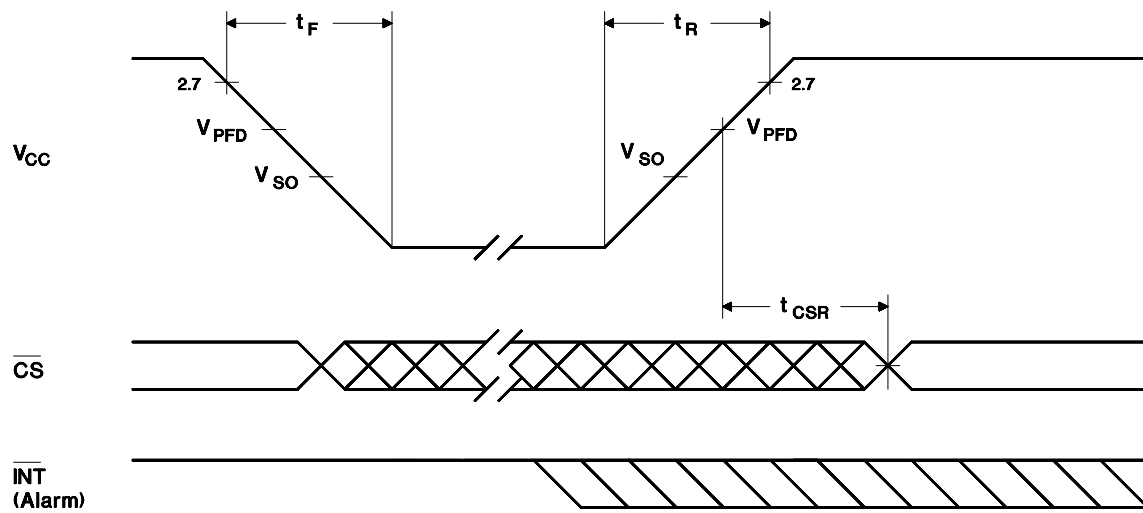
## bq3285EC/LC

### Power-Down/Power-Up Timing—bq3285LC ( $T_A = T_{OPR}$ )

| Symbol    | Parameter                                  | Minimum | Typical | Maximum | Unit    | Conditions                                                                    |
|-----------|--------------------------------------------|---------|---------|---------|---------|-------------------------------------------------------------------------------|
| $t_F$     | $V_{CC}$ slew from 2.7V to 0V              | 300     | -       | -       | $\mu s$ |                                                                               |
| $t_R$     | $V_{CC}$ slew from 0V to 2.7V              | 100     | -       | -       | $\mu s$ |                                                                               |
| $t_{CSR}$ | $\overline{CS}$ at $V_{IH}$ after power-up | 20      | -       | 200     | ms      | Internal write-protection period after $V_{CC}$ passes $V_{PFD}$ on power-up. |

**Caution:** Negative undershoots below the absolute maximum rating of -0.3V in battery-backup mode may affect data integrity.

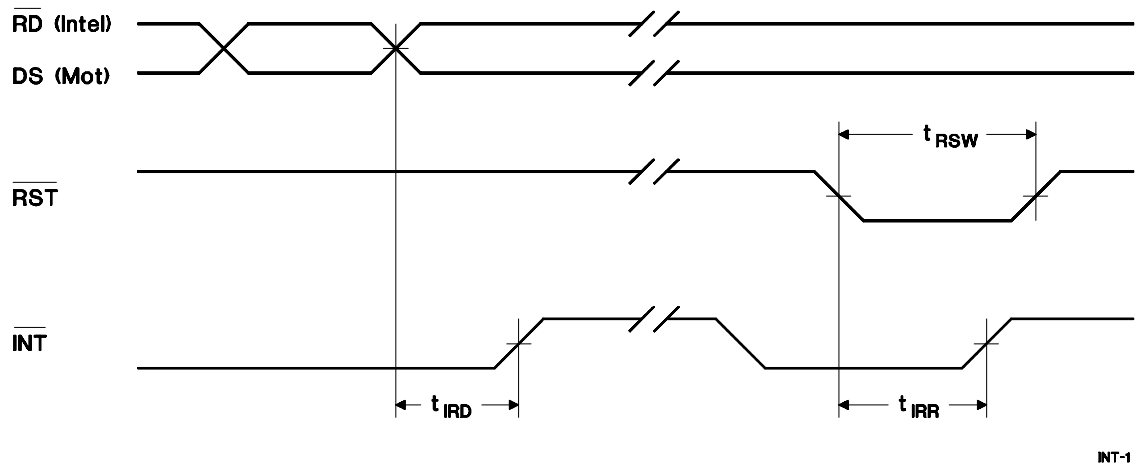
### Power-Down/Power-Up Timing—bq3285LC



PD-5

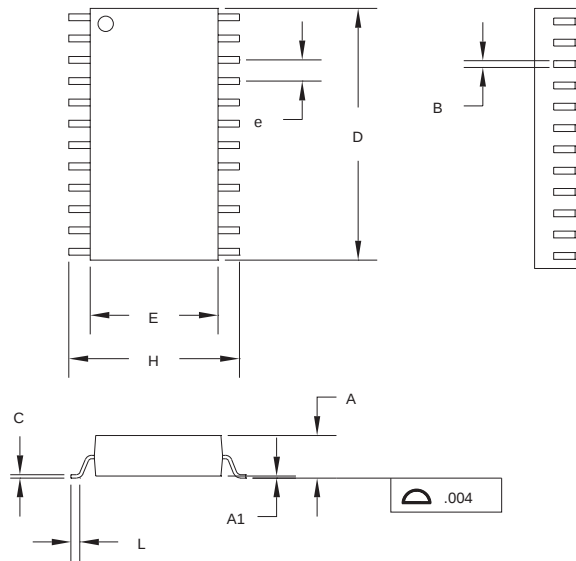
**Interrupt Delay Timing—bq3285EC/LC** ( $T_A = T_{OPR}$ )

| Symbol    | Parameter                                      | Minimum | Typical | Maximum | Unit    |
|-----------|------------------------------------------------|---------|---------|---------|---------|
| $t_{RSW}$ | Reset pulse width                              | 5       | -       | -       | $\mu s$ |
| $t_{IRR}$ | $\overline{INT}$ release from $\overline{RST}$ | -       | -       | 2       | $\mu s$ |
| $t_{IRD}$ | $\overline{INT}$ release from DS               | -       | -       | 2       | $\mu s$ |

**Interrupt Delay Timing—bq3285EC/LC**


## bq3285EC/LC

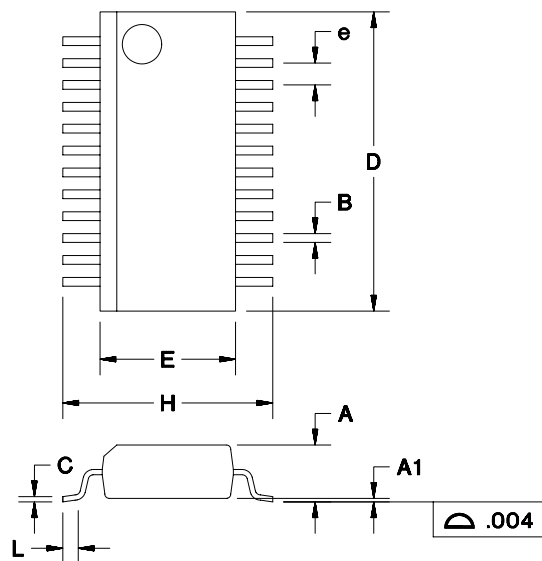
### 24-Pin SOIC (S)



#### 24-Pin S (0.300" SOIC)

| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min.   | Max.  | Min.        | Max.  |
| A         | 0.095  | 0.105 | 2.41        | 2.67  |
| A1        | 0.004  | 0.012 | 0.10        | 0.30  |
| B         | 0.013  | 0.020 | 0.33        | 0.51  |
| C         | 0.008  | 0.013 | 0.20        | 0.33  |
| D         | 0.600  | 0.615 | 15.24       | 15.62 |
| E         | 0.290  | 0.305 | 7.37        | 7.75  |
| e         | 0.045  | 0.055 | 1.14        | 1.40  |
| H         | 0.395  | 0.415 | 10.03       | 10.54 |
| L         | 0.020  | 0.040 | 0.51        | 1.02  |

### 24-Pin SSOP (SS)

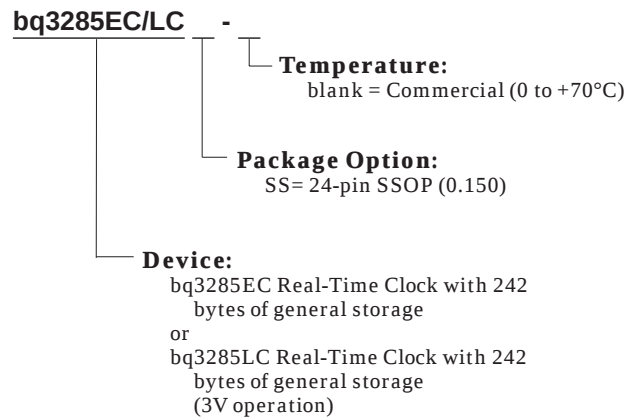


#### 24-Pin SS (0.150" SSOP)

| Dimension | Inches   |       | Millimeters |      |
|-----------|----------|-------|-------------|------|
|           | Min.     | Max.  | Min.        | Max. |
| A         | 0.061    | 0.068 | 1.55        | 1.73 |
| A1        | 0.004    | 0.010 | 0.10        | 0.25 |
| B         | 0.008    | 0.012 | 0.20        | 0.30 |
| C         | 0.007    | 0.010 | 0.18        | 0.25 |
| D         | 0.337    | 0.344 | 8.56        | 8.74 |
| E         | 0.150    | 0.157 | 3.81        | 3.99 |
| e         | .025 BSC |       | 0.64 BSC    |      |
| H         | 0.230    | 0.244 | 5.84        | 6.20 |
| L         | 0.016    | 0.035 | 0.41        | 0.89 |

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## Ordering Information



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С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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